

Small Signal Switching Diodes, Low Leakage Current



FEATURES

- Silicon planar diodes
- Saving space
- Hermetic sealed parts
- Fits onto SOD-323/SOT-23 footprints
- Electrical data identical with the devices BAQ33 to BAQ35, BAQ133 to BAQ135
- Very low reverse current
- Material categorization: for definitions of compliance please see www.vishay.com/doc?999912



RoHS
COMPLIANT
HALOGEN
FREE

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MECHANICAL DATA

Case: MicroMELF

Weight: approx. 12 mg

Cathode band color: black

Packaging codes / options:

TR3/10K per 13" reel (8 mm tape), 10K/box

TR/2.5K per 7" reel (8 mm tape), 12.5K/box

APPLICATIONS

- Protection circuits, time delay circuits, peak follower circuits, logarithmic amplifiers

PARTS TABLE

PART	TYPE DIFFERENTIATION	ORDERING CODE	CIRCUIT CONFIGURATION	REMARKS
BAQ333	$V_{RRM} = 40\text{ V}$	BAQ333-TR3 or BAQ333-TR	Single	Tape and reel
BAQ334	$V_{RRM} = 70\text{ V}$	BAQ334-TR3 or BAQ334-TR	Single	Tape and reel
BAQ335	$V_{RRM} = 140\text{ V}$	BAQ335-TR3 or BAQ335-TR	Single	Tape and reel

ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

PARAMETER	TEST CONDITION	PART	SYMBOL	VALUE	UNIT
Repetitive peak reverse voltage		BAQ333	V_{RRM}	40	V
		BAQ334	V_{RRM}	70	V
		BAQ335	V_{RRM}	140	V
Reverse voltage		BAQ333	V_R	30	V
		BAQ334	V_R	60	V
		BAQ335	V_R	125	V
Peak forward surge current	$t_p = 1\text{ }\mu\text{s}$		I_{FSM}	2	A
Forward continuous current			I_F	200	mA

THERMAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Thermal resistance junction to ambient air	Mounted on epoxy-glass hard tissue, fig. 4 35 μm copper clad, 0.9 mm^2 copper area per electrode	R_{thJA}	500	K/W
Junction temperature		T_j	175	$^{\circ}\text{C}$
Storage temperature range		T_{stg}	-65 to +175	$^{\circ}\text{C}$

ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	$I_F = 100\text{ mA}$		V_F			1	V
Reverse current	$E \leq 300\text{ lx}$, rated V_R		I_R		1	3	nA
	$E \leq 300\text{ lx}$, rated V_R , $T_J = 125\text{ }^{\circ}\text{C}$		I_R			0.5	μA
	$E \leq 300\text{ lx}$, $V_R = 15\text{ V}$	BAQ333	I_R		0.5	1	nA
	$E \leq 300\text{ lx}$, $V_R = 30\text{ V}$	BAQ334	I_R		0.5	1	nA
	$E \leq 300\text{ lx}$, $V_R = 60\text{ V}$	BAQ335	I_R		0.5	1	nA
Breakdown voltage	$I_R = 5\text{ }\mu\text{A}$, $t_p/T = 0.01$, $t_p = 0.3\text{ ms}$	BAQ333	$V_{(BR)}$	40			V
		BAQ334	$V_{(BR)}$	70			V
		BAQ335	$V_{(BR)}$	140			V
Diode capacitance	$V_R = 0\text{ V}$, $f = 1\text{ MHz}$		C_D			3	pF

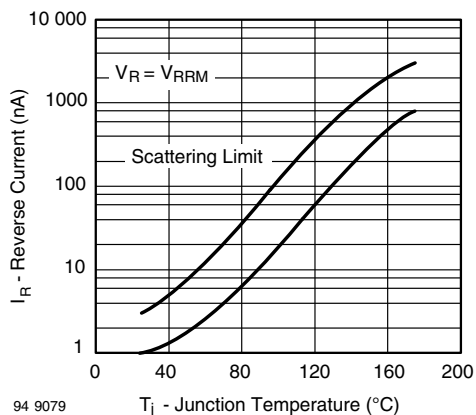
TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)


Fig. 1 - Reverse Current vs. Junction Temperature

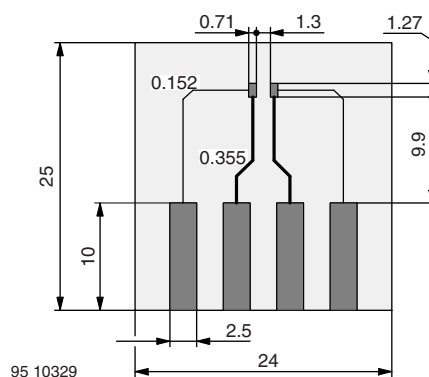
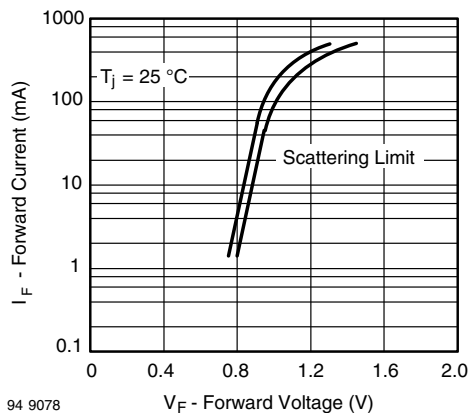
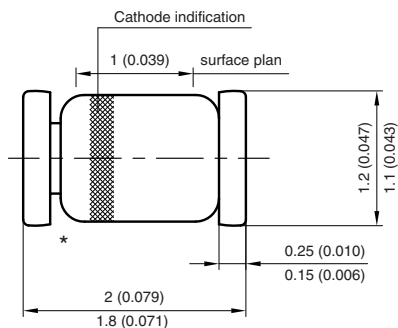

Fig. 3 - Board for R_{thJA} Definition (in mm)


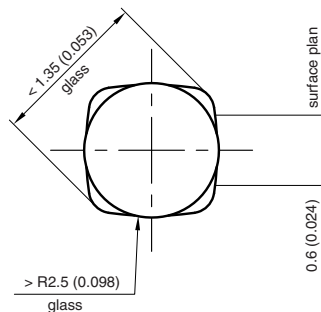
Fig. 2 - Forward Current vs. Forward Voltage



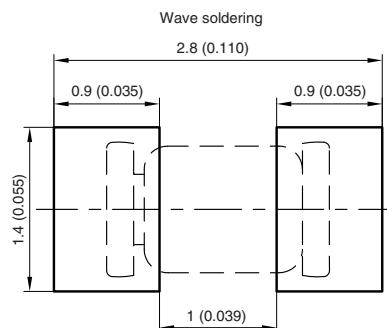
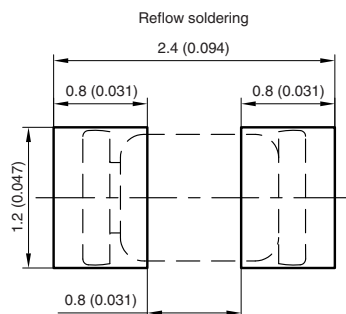
PACKAGE DIMENSIONS in millimeters (inches): **MicroMELF**



* The gap between plug and glass can be either on cathode or anode side



Foot print recommendation:



Created - Date: 26.July.1996
Rev. 13 - Date: 07.June.2006
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96 12072



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